CBT3861

10-bit bus switch with output enable Rev. 3 — 21 November 2011

Product data sheet

General description 1.

The CBT3861 provides ten bits of high-speed TTL-compatible bus switching. The low ON resistance of the switch allows connections to be made with minimal propagation delay.

The CBT3861 device is organized as one 10-bit bus switches with one output enable (OE) input. When \overline{OE} is LOW, the switch is on and port A is connected to the B port. When \overline{OE} is HIGH, each switch is disabled.

The CBT3861 is characterized for operation from -40 °C to +85 °C.

2. **Features and benefits**

- \blacksquare 5 Ω switch connection between two ports
- TTL-compatible control input levels
- Multiple package options
- Latch-up protection exceeds 100 mA per JESD78
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - ◆ CDM JESD22-C101C exceeds 1000 V

Ordering information

Table 1. **Ordering information**

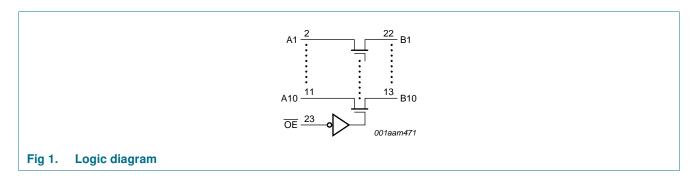
| Туре | Package | | | | | | | | | |
|-----------|-------------------|-----------|--|----------|--|--|--|--|--|--|
| number | Temperature range | Name | Description | Version | | | | | | |
| CBT3861PW | –40 °C to +85 °C | TSSOP24 | plastic thin shrink small outline package; 24 leads; body width 4.4 mm | SOT355-1 | | | | | | |
| CBT3861DK | –40 °C to +85 °C | SSOP24[1] | plastic shrink small outline package; 24 leads; body width 3.9 mm; lead pitch 0.635 mm | SOT556-1 | | | | | | |
| CBT3861BQ | –40 °C to +85 °C | DHVQFN24 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body $3.5\times5.5\times0.85$ mm | SOT815-1 | | | | | | |

^[1] Also known as QSOP24 package



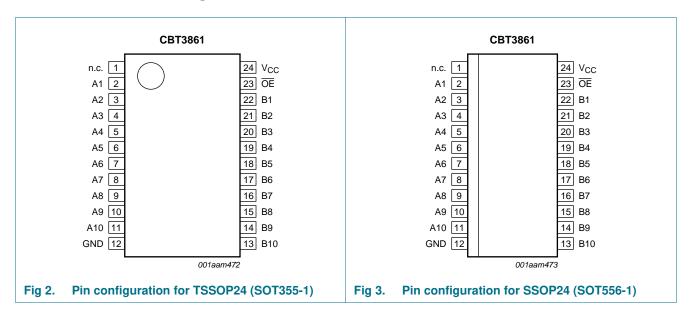
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4. Functional diagram

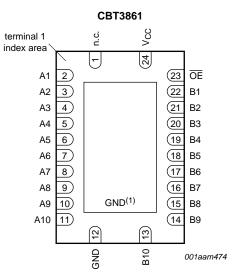


5. Pinning information

5.1 Pinning



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Transparent top view

(1) This is not a supply pin. The substrate is attached to this pad using conductive die attach material. There is no electrical or mechanical requirement to solder this pad. However, if it is soldered, the solder land should remain floating or be connected to GND

Fig 4. Pin configuration for DHVQFN24 (SOT815-1)

5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|-----------------|---------------------------------------|----------------------------------|
| nc | 1 | not connected |
| A1 to A10 | 2, 3, 4, 5, 6, 7, 8, 9, 10, 11 | data input/output (A port) |
| GND | 12 | ground (0 V) |
| B1 to B10 | 22, 21, 20, 19, 18, 17, 16, 15, 14, 1 | 3 data input/output (B port) |
| OE | 23 | output enable input (active LOW) |
| V _{CC} | 24 | positive supply voltage |

6. Functional description

Table 3. Function selection[1]

| Input OE | Input/output |
|-------------|--------------|
| OE | An, Bn |
| L | An = Bn |
| H | Z |

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

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7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). $T_{amb} = -40 \, ^{\circ}\text{C}$ to +85 $^{\circ}\text{C}$, unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|------------------------|----------------------|-----------------|------|------|
| V_{CC} | supply voltage | | -0.5 | +7.0 | V |
| V_{I} | input voltage | | <u>[2]</u> –0.5 | +7.0 | V |
| Io | output current | V _O < 0 V | - | ±128 | mA |
| I _{IK} | input clamping current | $V_{I/O} = 0 V$ | -50 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |

^[1] Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under <u>Section 8</u> is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

8. Recommended operating conditions

Table 5. Operating conditions

All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|--------------------------|-----------------------|-----|-----|-----|------|
| V_{CC} | supply voltage | | 4.5 | - | 5.5 | V |
| V _{IH} | HIGH-level input voltage | | 2.0 | - | - | V |
| V_{IL} | LOW-level input voltage | | - | - | 0.8 | V |
| T _{amb} | ambient temperature | operating in free air | -40 | - | +85 | °C |

9. Static characteristics

Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | T _{amb} = | -40 °C to ⋅ | +85 °C | Unit |
|----------------------|------------------------------------|---|--------------------|-------------|--------|------|
| | | | Min | Typ[1] | Max | |
| V_{IK} | input clamping voltage | $V_{CC} = 4.5 \text{ V}; I_I = -18 \text{ mA}$ | - | - | -1.2 | V |
| I _I | input leakage current | $V_{CC} = 5.5 \text{ V}; V_I = \text{GND or } 5.5 \text{ V}$ | - | - | ±1 | μΑ |
| I _{CC} | supply current | V_{CC} = 5.5 V; I_O = 0 mA; V_I = V_{CC} or GND | - | - | 3 | μА |
| ΔI_{CC} | additional supply current | per input pin; $V_{CC} = 5.5 \text{ V}$; one input at 3.4 V, other inputs at V_{CC} or GND | | - | 2.5 | mA |
| V_{pass} | pass voltage | output HIGH; $V_I = V_{CC} = 5.0 \text{ V}$; $I_O = -100 \mu A$ | 3.6 | 3.9 | 4.2 | V |
| Cı | input capacitance | control pins; $V_1 = 3 V \text{ or } 0 V$ | - | 3.0 | - | pF |
| $C_{\text{io(off)}}$ | off-state input/output capacitance | port off; $V_1 = 3 \text{ V or } 0 \text{ V}$; $\overline{OE} = V_{CC}$ | - | 5.0 | - | pF |

^[2] The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

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Table 6. Static characteristics ...continued Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | T _{amb} = | –40 °C to - | Unit | |
|----------|---------------|---|-----|--------------------|-------------|------|---|
| | | | | Min | Typ[1] | Max | |
| R_{ON} | ON resistance | $V_{CC} = 4.5 \text{ V}; V_I = 0 \text{ V}; I_I = 64 \text{ mA}$ | [3] | - | 5 | 7 | Ω |
| | | $V_{CC} = 4.5 \text{ V}; V_I = 0 \text{ V}; I_I = 30 \text{ mA}$ | [3] | - | 5 | 7 | Ω |
| | | $V_{CC} = 4.5 \text{ V}; V_I = 2.4 \text{ V}; I_I = -15 \text{ mA}$ | [3] | - | 10 | 15 | Ω |

^[1] All typical values are at $V_{CC} = 5 \text{ V}$, $T_{amb} = 25 \,^{\circ}\text{C}$.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

| Symbol | Parameter | Conditions | Conditions | | _{amb} = 25 ^c | C | T _{amb} = -40 ° | C to +85 °C | Unit |
|------------------|-------------------|-----------------------------------|------------|-----|----------------------------------|------|--------------------------|-------------|------|
| | | | | Min | Тур | Max | Min | Max | |
| t _{pd} | propagation delay | An, Bn to Bn, An; see Figure 5 | [1][2] | | | | | | |
| | | V_{CC} = 5.0 V \pm 0.5 V | | - | - | 0.25 | - | 0.25 | ns |
| t _{en} | enable time | OE to An or Bn; see Figure 6 | [2] | | | | | | |
| | | V_{CC} = 5.0 V \pm 0.5 V | | - | 3.3 | - | 1.6 | 7.5 | ns |
| t _{dis} | disable time | OE to An or Bn; see Figure 6 | [2] | | | | | | |
| | | V_{CC} = 5.0 V \pm 0.5 V | | - | 3.4 | - | 2.1 | 6.6 | ns |

^[1] The propagation delay is the calculated RC time constant of the typical ON resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

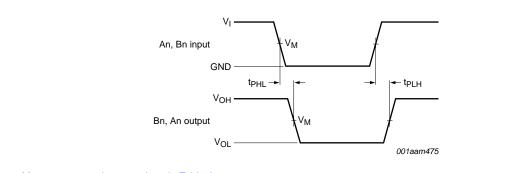
^[2] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

^[3] Measured by the voltage drop between the nAn and the nBn terminals at the indicated current through the switch. ON resistance is determined by the lowest voltage of the two (nAn or nBn) terminals.

 $[\]begin{array}{ll} [2] & t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}. \\ & t_{en} \text{ is the same as } t_{PZL} \text{ and } t_{PZH}. \\ & t_{dis} \text{ is the same as } t_{PLZ} \text{ and } t_{PHZ}. \end{array}$

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11. Waveforms



Measurement points are given in Table 8.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 5. The data input (An, Bn) to output (Bn, An) propagation delay times

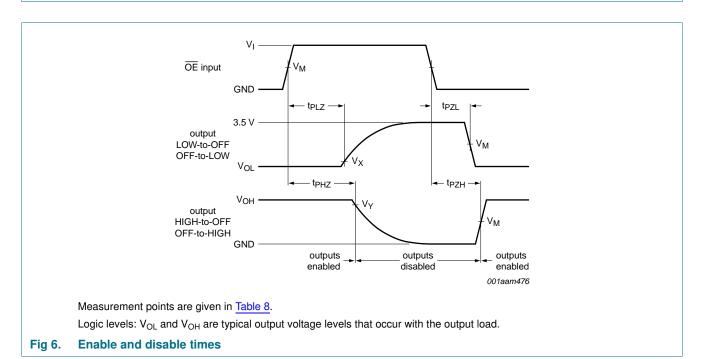
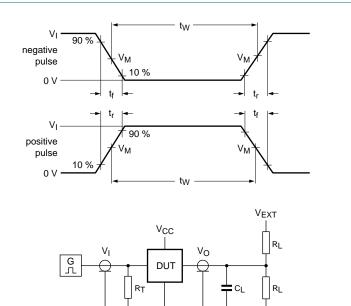


Table 8. Measurement points

| Supply voltage | Input | | Output | | | | |
|--|----------------|----------------|----------------|-------------------------|--------------------|--|--|
| V _{CC} | V _I | V _M | V _M | V_X | V _Y | | |
| $V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$ | GND to 3.0 V | 1.5 V | 1.5 V | V _{OL} + 0.3 V | $V_{OH} - 0.3 \ V$ | | |

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12. Test information



001aae331

Test data is given in Table 9.

All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz; $Z_0 = 50~\Omega$.

The outputs are measured one at a time with one transition per measurement.

Definitions for test circuit:

 R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 7. Test circuit for measuring switching times

Table 9. Test data

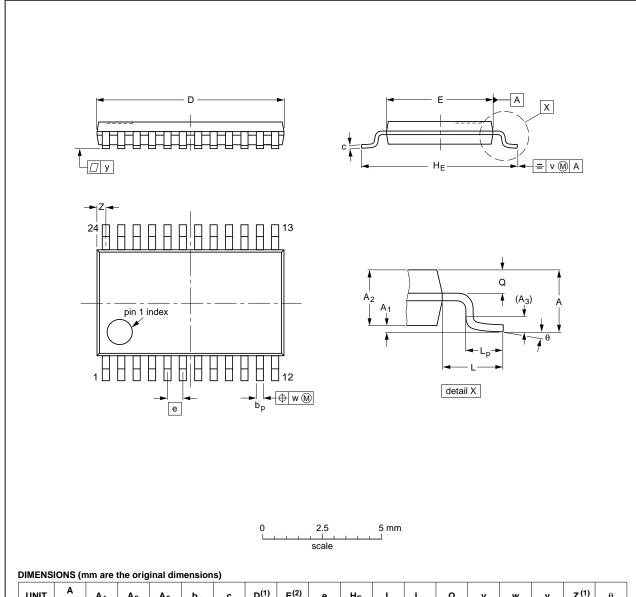
| Supply voltage | Input | | Load | | V _{EXT} | | | |
|------------------------------|--|----------|-------|----------------|-------------------------------------|-----------------------|-------------------------------------|--|
| | V _I t _r , t _f | | CL | R _L | t _{PLH} , t _{PHL} | t_{PLZ} , t_{PZL} | t _{PHZ} , t _{PZH} | |
| V_{CC} = 5.0 V \pm 0.5 V | GND to 3.0 V | ≤ 2.5 ns | 50 pF | 500Ω | open | 7.0 V | open | |

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13. Package outline

TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm

SOT355-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | bp | C | D ⁽¹⁾ | E ⁽²⁾ | e | HE | L | Lp | Q | ٧ | w | у | Z ⁽¹⁾ | θ |
|------|-----------|----------------|----------------|----------------|--------------|------------|------------------|------------------|------|------------|---|--------------|------------|-----|------|-----|------------------|----------|
| mm | 1.1 | 0.15 0.05 | 0.95 0.80 | 0.25 | 0.30 0.19 | 0.2 0.1 | 7.9 7.7 | 4.5 4.3 | 0.65 | 6.6 6.2 | 1 | 0.75 0.50 | 0.4 0.3 | 0.2 | 0.13 | 0.1 | 0.5 0.2 | 8° 0° |

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE | | REFER | | EUROPEAN | ISSUE DATE | |
|----------|-----|--------|-------|----------|------------|---------------------------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT355-1 | | MO-153 | | | | 99-12-27 03-02-19 |
| | l | l | | l | _ T | 11 02 10 |

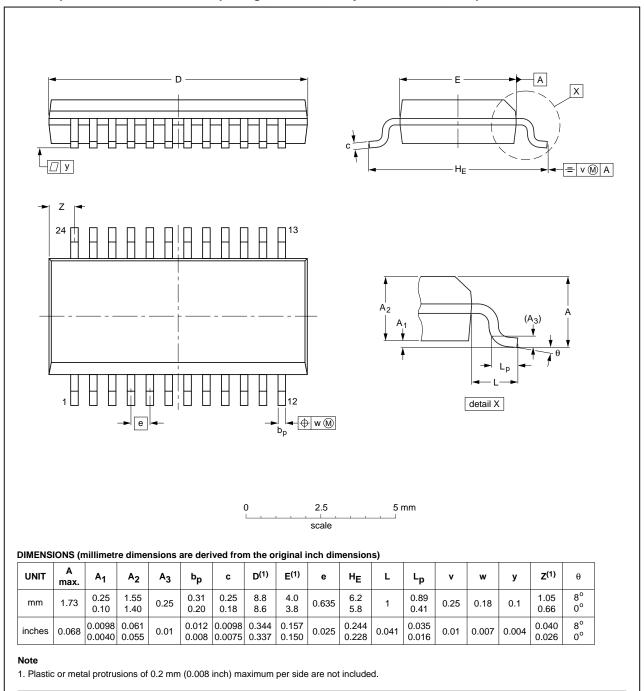
Fig 8. Package outline SOT355-1 (TSSOP24)

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SSOP24: plastic shrink small outline package; 24 leads; body width 3.9 mm; lead pitch 0.635 mm SOT556-1



| OUTLINE VERSION | REFERENCES | | | | EUROPEAN | ISSUE DATE |
|--------------------|------------|--------|-------|--|------------|---------------------------------|
| | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT556-1 | | MO-137 | | | | 99-12-27 03-02-18 |

Fig 9. Package outline SOT556-1 (SSOP24)

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DHVQFN24: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body $3.5 \times 5.5 \times 0.85$ mm

SOT815-1

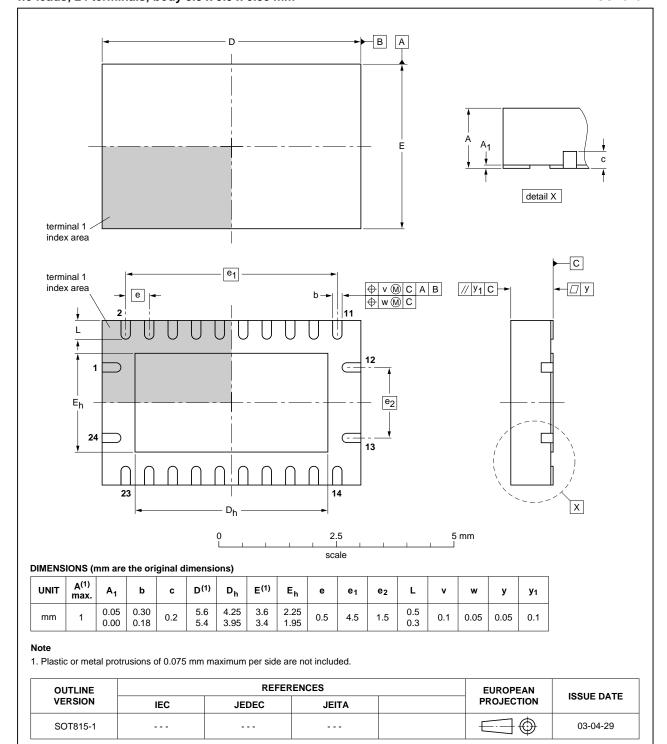


Fig 10. Package outline SOT815-1 (DHVQFN24)

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14. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|-----------------------------|
| CDM | Charged Device Model |
| ESD | ElectroStatic Discharge |
| НВМ | Human Body Model |
| PRR | Pulse Rate Repetition |
| TTL | Transistor-Transistor Logic |

15. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|---------------------------------|--------------------|---------------|-------------|
| CBT3861 v.3 | 20111121 | Product data sheet | - | CBT3861 v.2 |
| Modifications: | Legal pages | updated. | | |
| CBT3861 v.2 | 20101124 | Product data sheet | - | CBT3861 v.1 |
| CBT3861 v.1 | 20100819 | Product data sheet | - | - |

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|--------------------------------|-------------------|---|
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